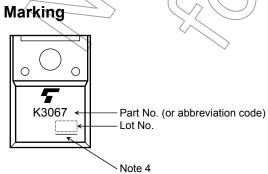
## **Electrical Characteristics (Ta = 25°C)**

Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage current		$I_{GSS}$	V <sub>GS</sub> = ±25 V, V <sub>DS</sub> = 0 V	_	_	±10	μΑ
Gate-source breakdown voltage		V (BR) GSS	$I_G = \pm 10 \ \mu A, \ V_{DS} = 0 \ V$	±30	_		V
Drain cut-off current		I <sub>DSS</sub>	V <sub>DS</sub> = 600 V, V <sub>GS</sub> = 0 V	/	_	100	μΑ
Drain-source breakdown voltage		V (BR) DSS	I <sub>D</sub> = 10 mA, V <sub>GS</sub> = 0 V	600			V
Gate threshold voltage		$V_{th}$	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 1 mA	2.0	) }_	4.0	V
Drain-source ON resistance		R <sub>DS</sub> (ON)	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 1 A	$\nearrow$	4.2	5.0	Ω
Forward transfer admittance		Y <sub>fs</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 1 A	0.8	1.7	_	S
Input capacitance		C <sub>iss</sub>		)	380		
Reverse transfer capacitance		C <sub>rss</sub>	V <sub>DS</sub> = 10 V, V <sub>GS</sub> = 0 V, f = 1 MHz	` —	40		pF
Output capacitance		C <sub>oss</sub>		_	120	  -	
Switching time	Rise time	t <sub>r</sub>	$V_{GS} \stackrel{10V}{\text{ov}} \prod \stackrel{ID=1A}{\bigvee} V_{OUT}$	- (	15	> - -	
	Turn-on time	t <sub>on</sub>	$R_L = 200\Omega$	DV/	25	) _	- ns
	Fall time	t <sub>f</sub>	v <sub>DD</sub> = 200V		20		
	Turn-off time	t <sub>off</sub>	Duty $\leq 1\%$ , $t_{\mathbf{W}} = 10 \mu s$	) –	80		
Total gate charge (Gate-source plus gate-drain)		Qg			9	_	_
Gate-source charge		Q <sub>gs</sub>	$V_{DD} \approx 480 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 2 \text{ A}$	_	5	_	nC
Gate-drain ("miller") charge		Qgd			4	_	

## Source-Drain Ratings and Characteristics (Tc = 25°C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current(Note 1)	I <sub>DR</sub>	_	_	_	2	Α
Pulse drain reverse current (Note 1)	IDRP	t = 1 ms	ı	1	5	Α
ruise diairreverse current (Note 1)	IDRP	t = 100 μs	l	1	8	Α
Forward voltage (diode)	V <sub>DSF</sub>	I <sub>DR</sub> = 2 A, V <sub>GS</sub> = 0 V	l	1	-1.5	>
Reverse recovery time	t <sub>rr</sub>	I <sub>DR</sub> = 2 A, V <sub>GS</sub> = 0 V		1000		ns
Reverse recovery charge	Ø <sup>tí</sup>	dl <sub>DR</sub> / dt = 100 A / μs	_	5.0	_	μC



Note 4: A line under a Lot No. identifies the indication of product Labels.

Not underlined: [[Pb]]/INCLUDES > MCV Underlined: [[G]]/RoHS COMPATIBLE or [[G]]/RoHS [[Pb]]

Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of Product. The RoHS is the Directive 2002/95/EC of the European Parliament and of the Council of 27 January 2003 on the restriction of the use of certain hazardous substances in electrical and electronic equipment.

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